Introductory Overview
Week2

Hacettepe University

>> Contents

Outline

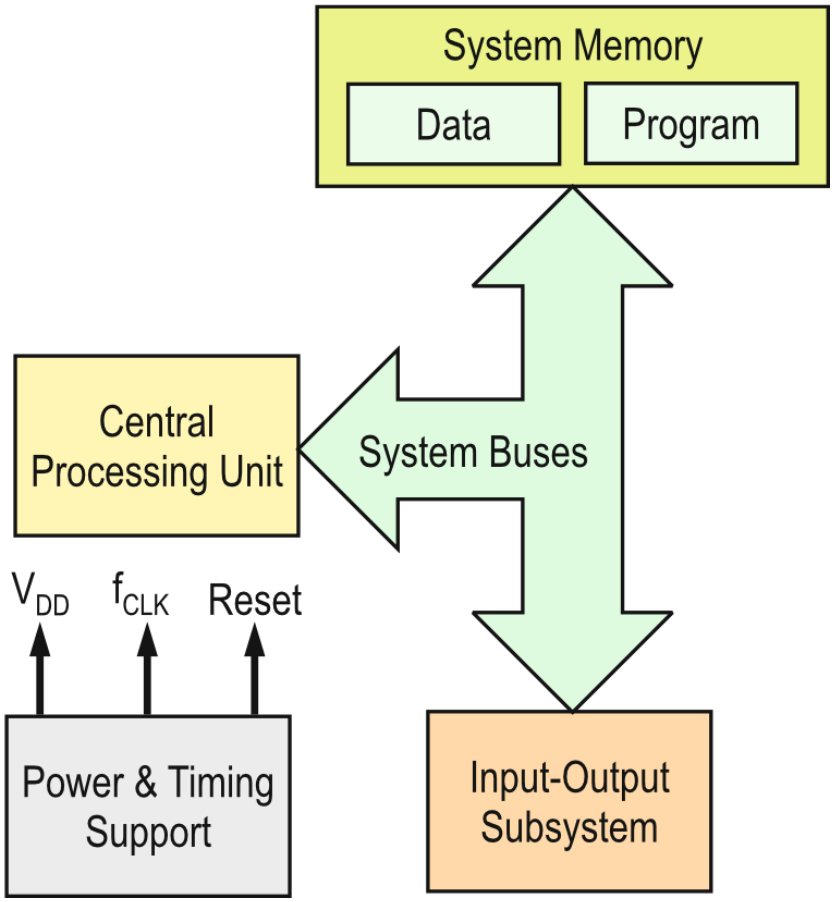
- Microcontrollers Versus Microprocessors
- Central Processing Unit
- System Buses
- Memory Organization
- I/O Subsystem Organization
- CPU Instruction Set
- MSP430 Instructions and Addressing Modes
- Introduction to Interrupts
- Notes on Program Design
- The TI MSP430 Microcontroller Family
- Development Tools

Microprocessors vs.

- Abbreviated as MPUs
- Contain a General Purpose CPU
  - ALU, CU, Registers, & BIU
- Require External Components to form a basic system
  - Buses
  - Memory
  - I/O interfaces & devices
- Additional Characteristics
  - Architecture optimized for accelerating data processing
  - Include elements to accelerate instruction execution ?

Microprocessors vs.

Fig. 3.1 General architecture of a microcomputer system



- Central Processing Unit
- System Memory
- Program Memory
- Data Memory
- Input-Output Subsystem
- System Buses
- Address bus
- Data bus
- Control bus
- Power & Support Logic

>> Contents

Microcontrollers

- A microcontroller is a functional computer system-on-a-chip. It contains a processor, memory, and programmable input/output peripherals.
- Microcontrollers include an integrated CPU, memory (a small amount of RAM, program memory, or both) and peripherals capable of input and output.
- Abbreviated as MCUs
- Contain a CPU
- Usually less complex than that of an MPU

Microcontrollers

- Include memory and peripherals in a single chip
- Denominated computer-on-a-chip
- Most MCUs do not provide external buses
- On-chip Memory
- Includes both program and data memory
- Include typical Peripherals
- Timers
- I/O ports
- Data converters etc..

Microcontrollers

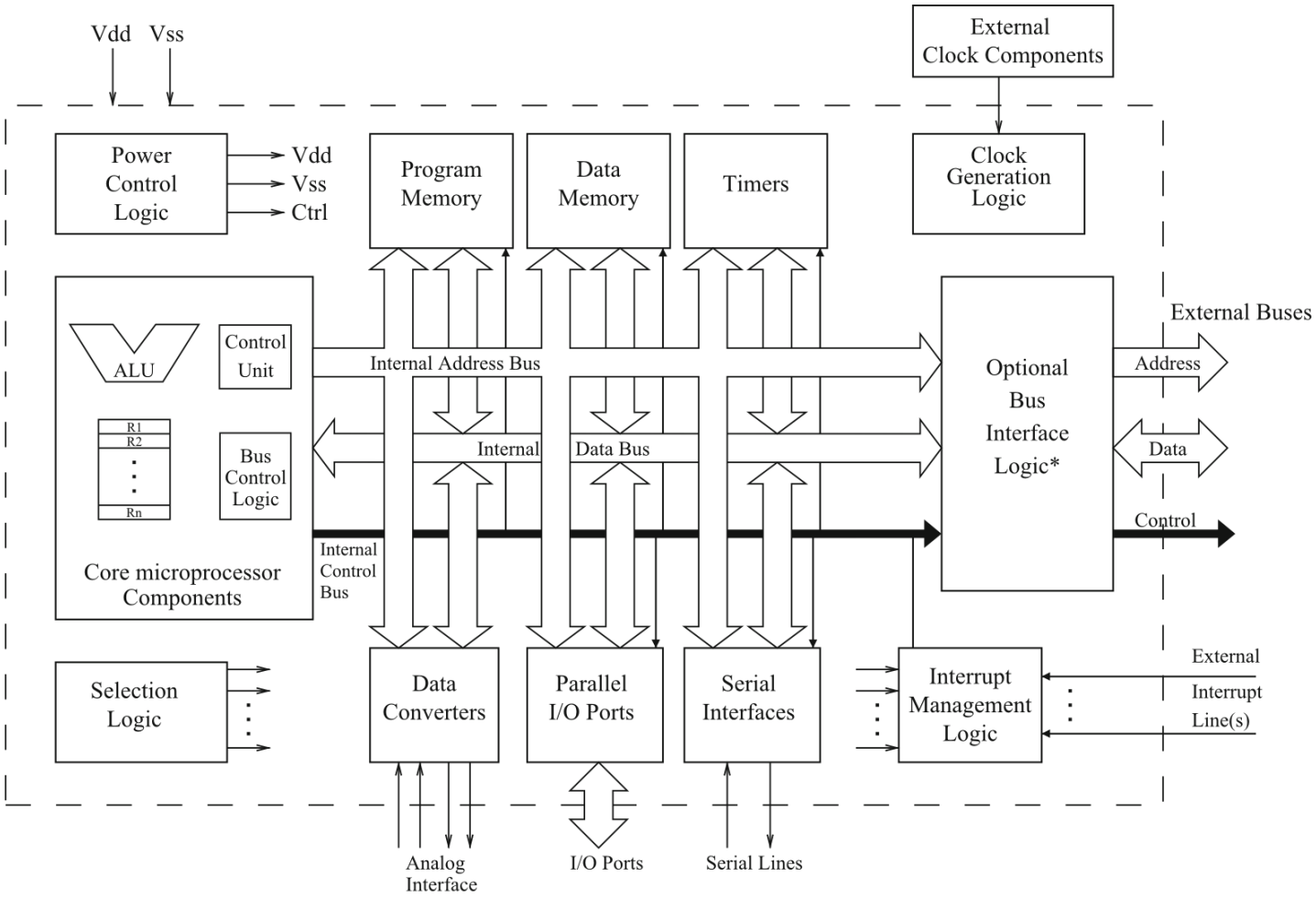


Fig. 3.2 Structure of a typical microcontroller

Table 3.1 A sample of MCU families/series

Company	4-bits	8-bits	16-bits	32-bits
EM Microelectronic	EM6807	EM6819		
Samsung	S3P7xx	S3F9xxx	S3FCxx	S3FN23BXZZ
Freescale semiconductor		68HC11	68HC12	
Toshiba		TLCS-870	TLCS-900/L1	TLCS-900/H1
Texas instruments			MSP430	TMS320C28X
			TMS320C24X	Stellaris line
Microchip		PIC1X	PIC2x	PIC32

INTEL

8031,8032,8051,8052,8751,8752

PIC

8-bit PIC16, PIC18,
16-bit DSPIC33 / PIC24,
PIC16C7x

Motorola

MC68HC11

TI MSP430

MICROPROCESSOR Vs MICROCONTROLLER

MICROPROCESSOR	MICROCONTROLLER
The functional blocks are ALU, registers, timing & control units	It includes functional blocks of microprocessors & in addition has timer, parallel i/o, RAM, EPROM, ADC & DAC
Bit handling instruction is less, One or two type only	Many type of bit handling instruction
Rapid movements of code and data between external memory & MP	Rapid movements of code and data within MC
It is used for designing general purpose digital computers system	They are used for designing application specific dedicated systems

RISC VS CISC

CISC (Complex Instruction Set Computer)

- Variable length instructions
- Large instruction set
- Focuses in accomplishing as much as possible with each instruction
  - Helps programmer's tasks
  - Augments hardware complexity

RISC (Reduced Instruction Set Computer)

- Fixed length instructions
- Short (reduced) instruction set
- Focuses on simple instructions
  - Makes programming harder
  - Simplifies the hardware structure

CPU COMPONENTS

- Hardware
  - Control unit (CU)
  - Arithmetic Logic Unit (ALU)
  - Register set
  - Bus interface logic (BIL)
- Software
  - Instruction set
  - Addressing modes

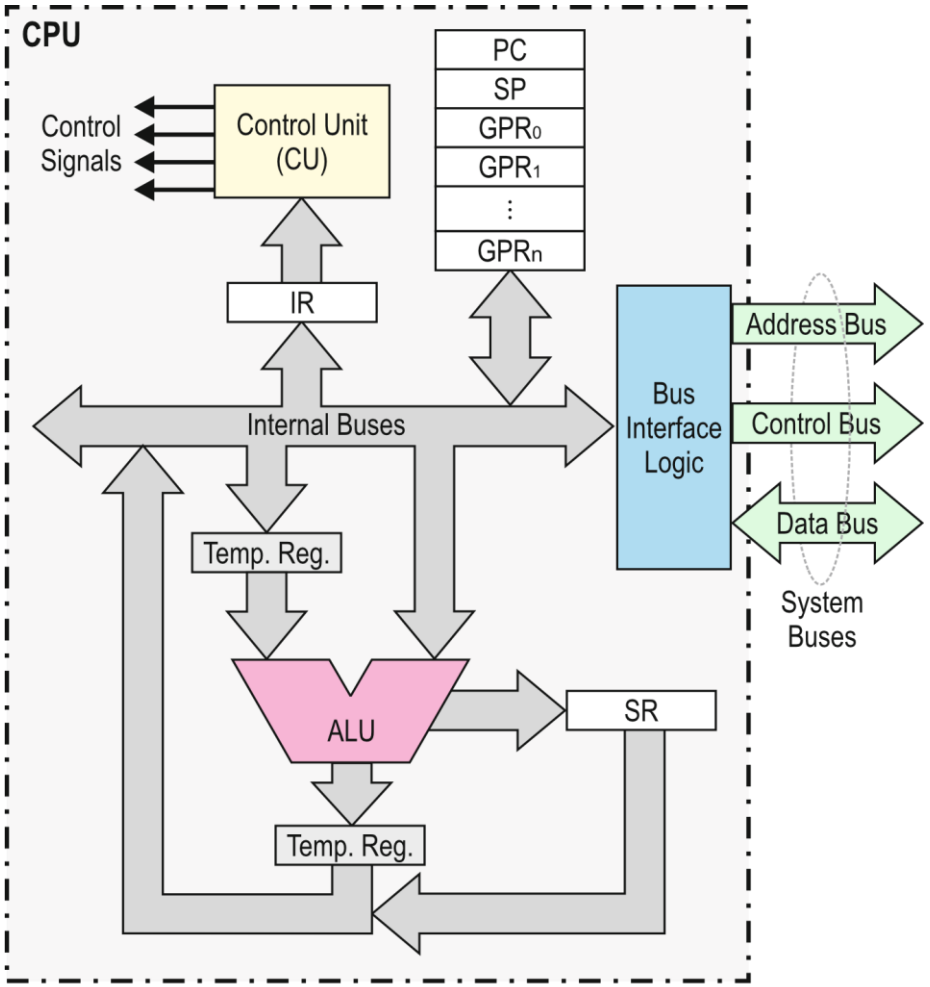
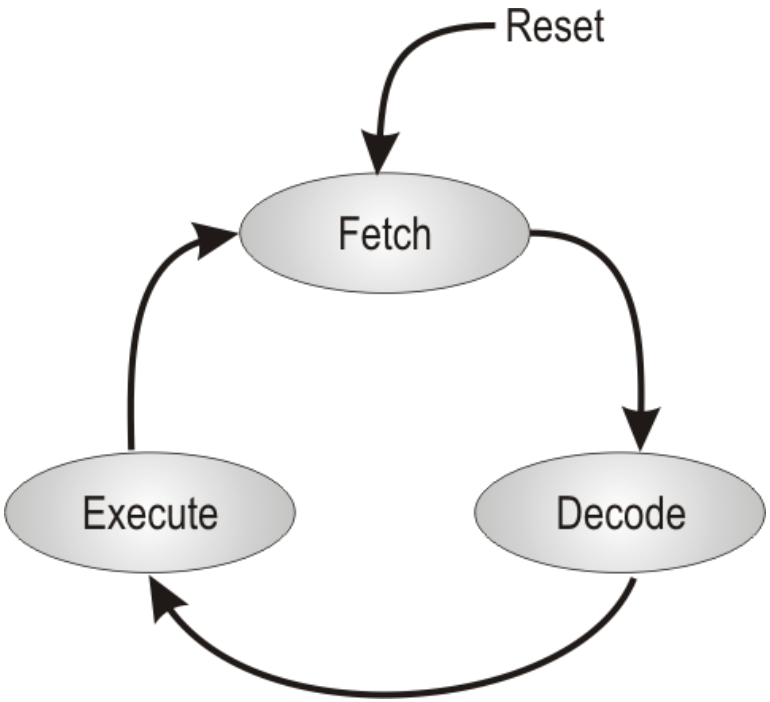


Fig. 3.3 Minimal architectural components in a simple CPU

CONTROL UNIT

- **Operation**
  - Governs the CPU working like a finite state machine
  - Cycles forever through three states:
    - Fetch
    - Decode, and
    - Execute
  - The fetch-decode-execute cycle is also known as the instruction cycle or CPU cycle



>> Contents

CONTROL UNIT

- Fetch
  - The program counter (PC) provides the address of the instruction to be fetched from memory
  - The instruction pointed by the PC is brought from memory into the CPU's instruction register (IR)
- Decode
  - The instruction meaning is deciphered
  - The decoded information is used to send signals to the appropriate CPU components to execute the instruction
- Execute
  - The CU commands the corresponding functional units to perform the actions specified by the instruction
  - At the end of the execution phase, the PC has been incremented to point to the address of the next instruction in memory

ARITHMETIC LOGIC UNIT

- Performs Supported Logic and Arithmetic Operations
  - Logic: AND, OR, NOT, XOR, SHIFT, ROTATE
  - Arithmetic: ADD, SUB, CMP
- Datapath Width
  - Established by the ALU operand width
  - Also sets the width of the data bus and data registers
- Example: A 16-bit CPU
  - 16-bit ALU operands
  - 16-bit Data bus
  - 16-bit Registers

BUS INTERFACE UNIT

- Coordinates the interaction between the internal buses and the system buses,
- Defines how the external address, data, and control buses operate
- Present even in MCUs with no external buses to coordinate internal bus activity
- Transparent to the programmer

>> Contents

SYSTEM BUS

- Data bus
  - Set of lines carrying data and instructions
  - Data bus lines are bidirectional to allow for reads & writes
  - READ: A transfer into a CPU register from memory or I/O
  - WRITE: A transfer or from a CPU register to memory or I/O
- Address bus
  - Set of lines transporting the address information which uniquely identifies a data cell in memory or peripheral device
- Control bus
  - Set of lines carrying the signals that regulate the system activity

REGISTERS

- Provide temporary storage for:
  - Data & operands
  - Memory addresses
  - Control words
- Fastest form of storage
- Smallest Capacity
- Volatile Contents
  - Contents lost when CPU is de-energized
- Register Types
  - General Purpose
  - Special Purpose

GP REGISTERS

- Are not tied to specific functions
  - Are available for programmer's general usage
- Can hold data, variables, or addresses
  - Usage depend on addressing mode and programmer's designation
- Number of registers depend on CPU architecture
  - Accumulator architectures have only a few
    - Some as little as two GP registers
  - RISC CPUs use a register file with dozens of registers

SP REGISTERS

- Instruction Register (IR)

Holds the instruction being currently decoded and executed

- Program Counter (PC)

Holds the address of the next instruction to be fetched from memory

- Stack Pointer (SP)

Holds the address of the current top-of-stack (TOS)

- Status Register (SR)

Holds the current CPU status

  - Status is indicated by a set of *flags*
  - A Flag: an individual bit indicating some condition

Flag REGISTERS

- Zero Flag (ZF)
  - Set when the result of an ALU operation is zero, and cleared otherwise
- *Carry Flag (CF)*
  - Set when an ALU arithmetic operation produces a carry
- *Negative* or *sign flag* (*NF*)
  - Set if the result of an ALU operation is negative and cleared otherwise
- *Overflow Flag (VF)*
  - This flag signals overflow in ALU addition or subtraction operations with signed numbers
- *Interrupt Flag (IF)*
  - Also called the *Global Interrupt Enable* (GIE)
  - Is not associated to the ALU status
  - Indicates whether or not the CPU would accept interrupt

Example 3.1 *The following operations are additions performed by the ALU using 8-bit data. For each one, determine the Carry, Zero, Negative, and Overflow flags.*

```
  01001010 +      10110100 +      10011010 +      11001010 +
  01111001 =      01001100 =      10111001 =      00011011 =
-----------     -----------     -----------     -----------
 0 11000011      1 00000000      1 01010011      0 11100101
 ↑ ↑             ↑ ↑             ↑ ↑             ↑ ↑
 C N             C N             C N             C N
```

Solution: *The operands have eight bits, so this length is our reference for the flags when we look at the result. The most significant bit in this group is flag* N. *The bit to the left is* C. *In hex form, these additions are, respectively,* 4Ah + 79h = C3h; B4h + 4Ch = 100h; 9Ah + B9h = 153h; *and* CAh + 1Bh = E5h. *The zero flag is set if the result is 0, discarding the carry, and the overflow flag is set if the addition of numbers of the same sign (that is, with equal most significant bit) yield a result of different sign (signaled by N). With this information we have then:*

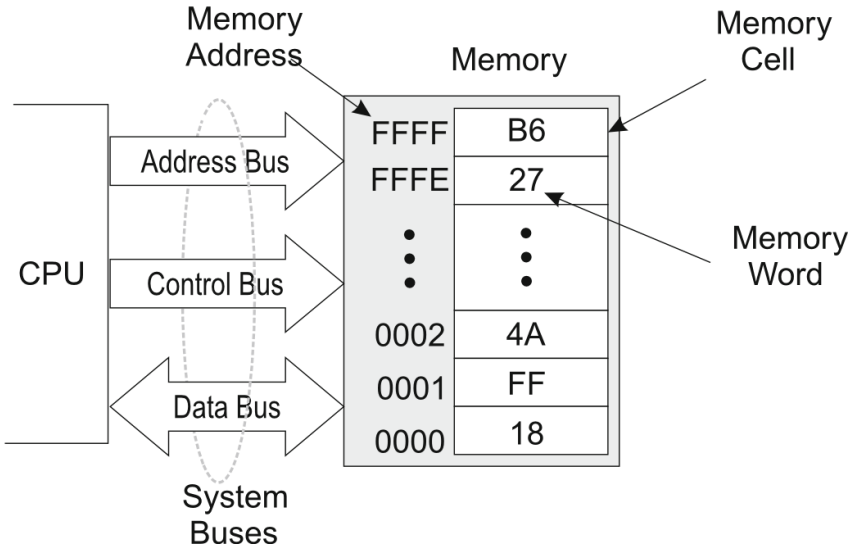
Operation 4Ah + 79h = C3h : C = 0, N = 1, Z = 0 *and* V = 1.
Operation B4h + 4Ch = 100h : C = 1, N = 0, Z = 1 *and* V = 0.
Operation 9Ah + B9h = 153h : C = 1, N = 0, Z = 0 *and* V = 1.
Operation CAh + 1Bh = E5h : C = 0, N = 1, Z = 0 *and* V = 0.

MEMORY ORGANIZATION

- Data Address: Little and Big Endian Conventions
- Program and Data Memory
- Von Neumann and Harvard Architectures
- Memory and CPU Data Exchange: An Example
- Memory Map
- MSP430 Memory Organization

MEMORY ORGANIZATION

- The memory subsystem is organized as an array of cells or locations
- Each memory location is identified by an address
- The contents of a memory cell is a word
  - A memory word may store instructions or data



>> Contents

MEMORY TYPES

Storage	Memory	In-system Writable	Comments
Nonvolatile	Masked ROM	No	Non programmable
	OTPROM	No	One time programmable with programming device
	EPROM	No	Erasable and programmable with external device
	EEPROM	Yes	Slow to erase/write. Not advisable to write during program execution. Requires higher voltage.
	Flash	Yes	Similar to EEPROM
	FRAM	Yes	Fast to write at low voltage
Volatile	Static RAM	Yes	Fastest to write/read
	DRAM	Yes	Fast to write/read

Fig. 3.7 Memory types

Memory

- **Volatile:** Loses its contents when power is removed.
  - Static
  - Dynamic
- **Nonvolatile:** Retains its contents when power is removed and is therefore used for the program and constant data. Usually slower than writing to RAM
  - **Masked ROM:** The data are encoded into one of the masks used for photolithography and written into the IC during manufacture. This memory really is read-only. Used for the high-volume production of stable products, because any change to the data requires a new mask to be produced at great expense. Some MSP430 devices can be ordered with ROM, shown by a *C* in their part number. For ex: MSP430CG4619.
  - **OTP (one-time programmable memory):** This is just EPROM in a normal package without a window, which means that it cannot be erased. Devices with OTP ROM are still widely used and the first family of the MSP430 used this technology.

Memory

- **EPROM** (electrically programmable ROM): As its name implies, it can be programmed electrically but not erased. Devices must be exposed to ultraviolet (UV) light for about ten minutes to erase them. The usual black epoxy encapsulation is opaque, so erasable devices need special packages with quartz windows, which are expensive. These were widely used for development before flash memory was widely available.
- **Flash memory:** This can be both programmed and erased electrically and is now by far the most common type of memory. It has largely superseded electrically erasable, programmable ROM (EEPROM). The practical difference is that individual bytes of EEPROM can be erased but flash can be erased only in blocks. Most MSP430 devices use flash memory, shown by an *F* in the part number

EXAMPLE MEMORY BANK CONNECTION

MEMORY BANK: Memory blocks of one byte are called bank
MEM SEGMENT: A set of memory words with continuous addressing

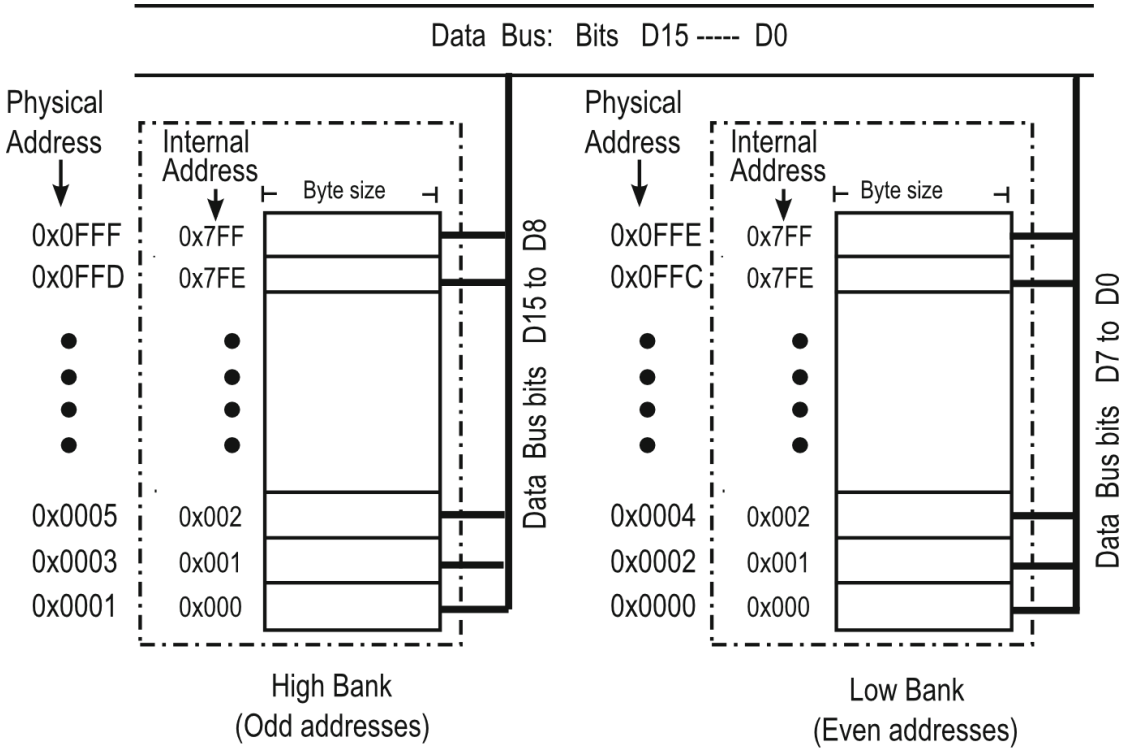
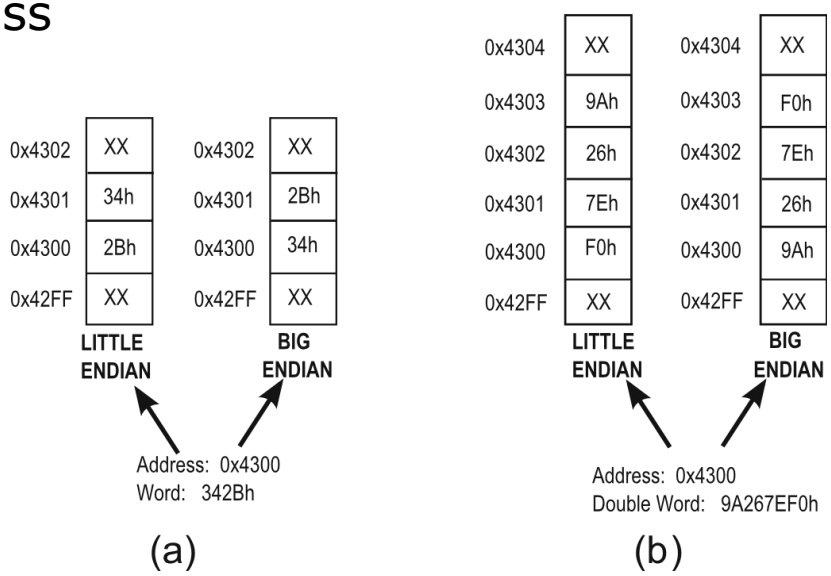


Fig. 3.8 Example of bank connection

40BF003A0120 has the address F8AAh ?

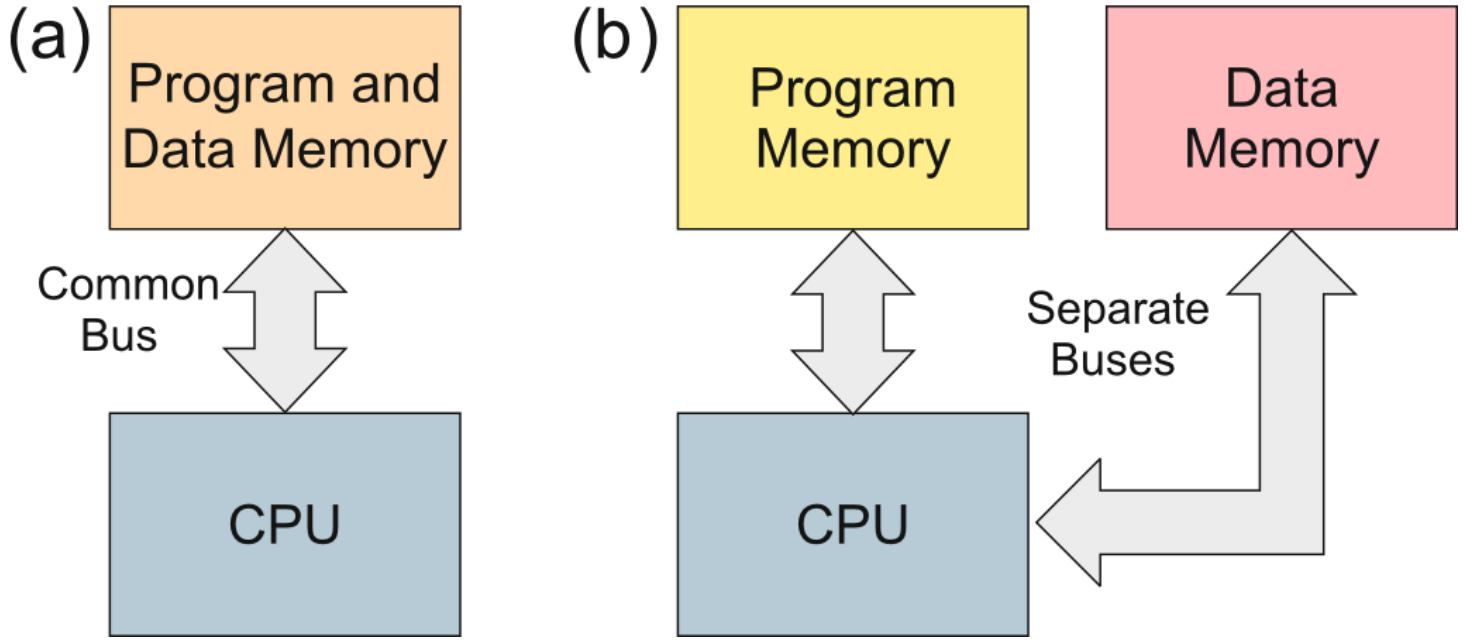
ENDIANNESS

- Big Endian:
  - Data is stored with the most significant byte in the lowest address and the least significant byte in the highest address
- Little Endian
  - Data is stored the the least significant byte in the lowest address and the most significant byte in the highest address



MCU ARCHITECTURES

- Von Neumann
  - A single set of buses for accessing both programs and data and a single address space
- Harvard
  - Uses separate buses for accessing programs and data and has separate address spaces



>> Contents

Harvard and von Neumann Architectures

- Harvard: The volatile (data) and nonvolatile (program) memories are treated as separate systems, each with its own address and data bus.
  - Simulataneous Access!
  - Individually Optimized.
  - Microchip PICs, the Intel 8051 and the ARM9.
- Von Neumann
  - Easier architecture.
  - MSP430, Freescale HCS08, and the ARM7.

CONCEPTUAL MEMORY CONNECTION

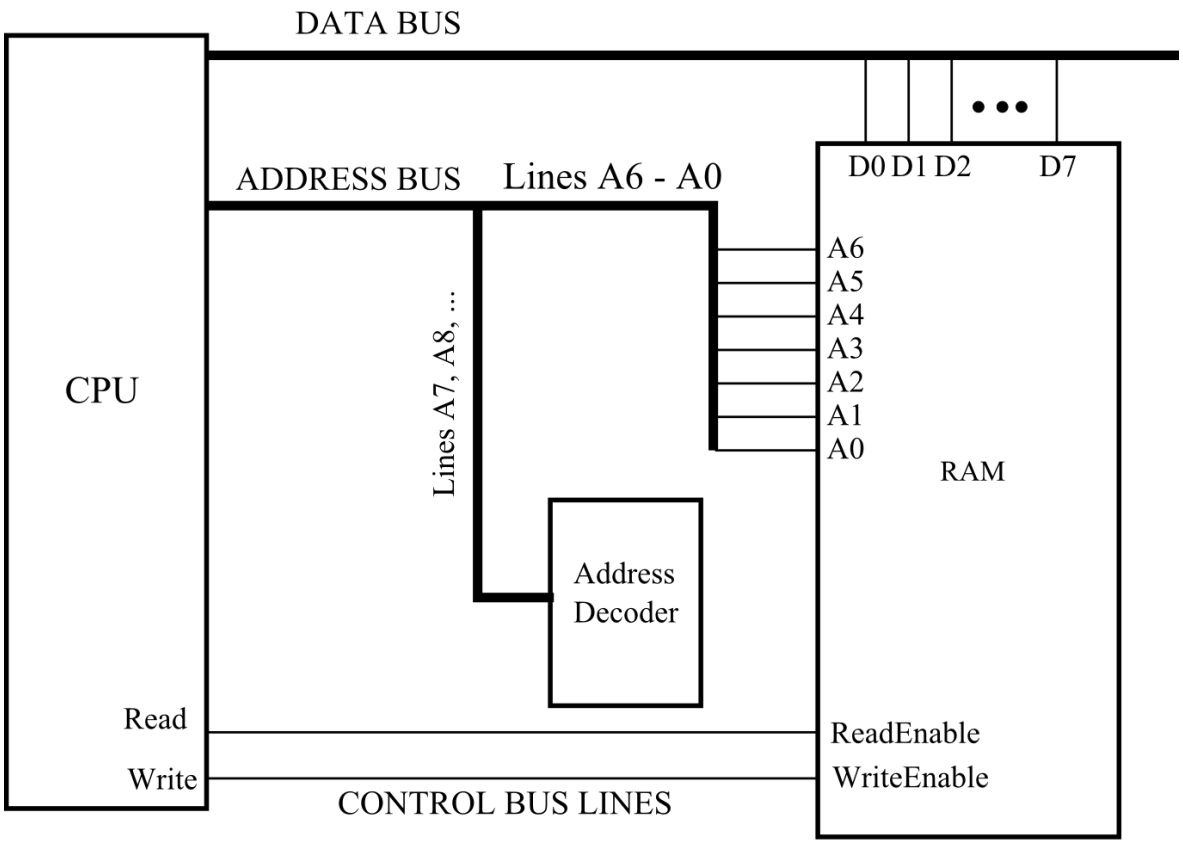


Fig. 3.11 CPU to memory connection: a conceptual scheme

256B Memory Example

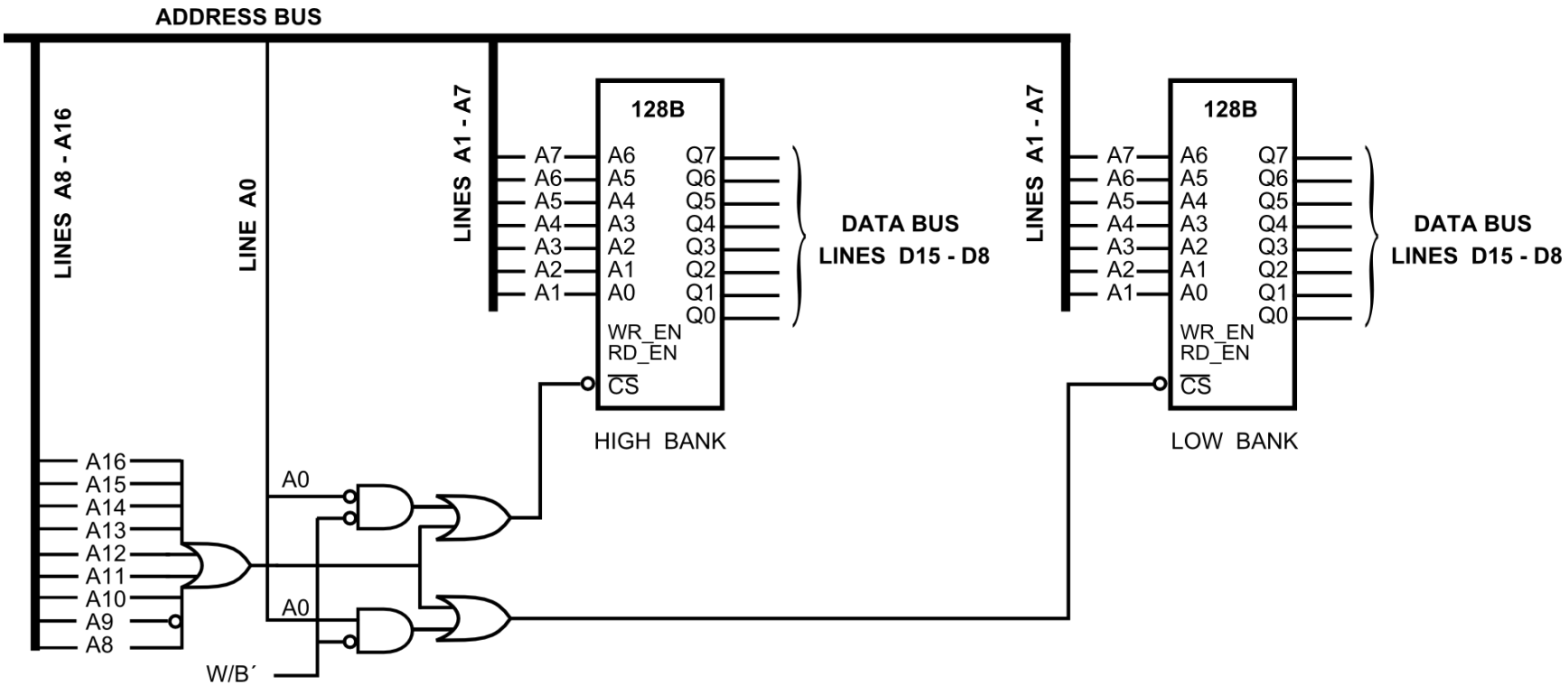


Fig. 3.12 256B memory bank example

A General Memory Map Example

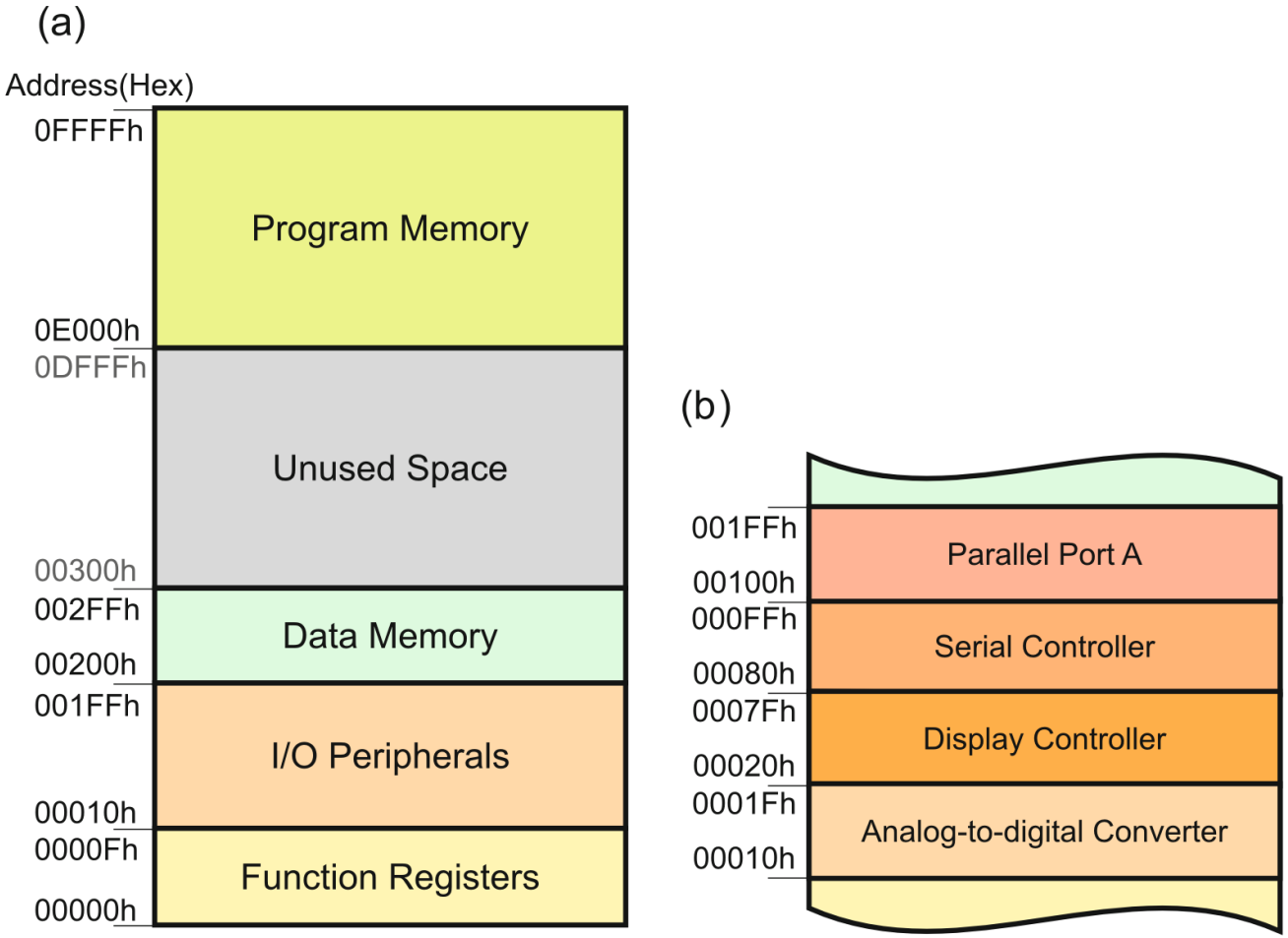


Fig. 3.13 Example memory map for a microcomputer with a 16-bit address bus. **a** Global memory gap, **b** Partial memory map

MSP430 MEMORY ORGANIZATION

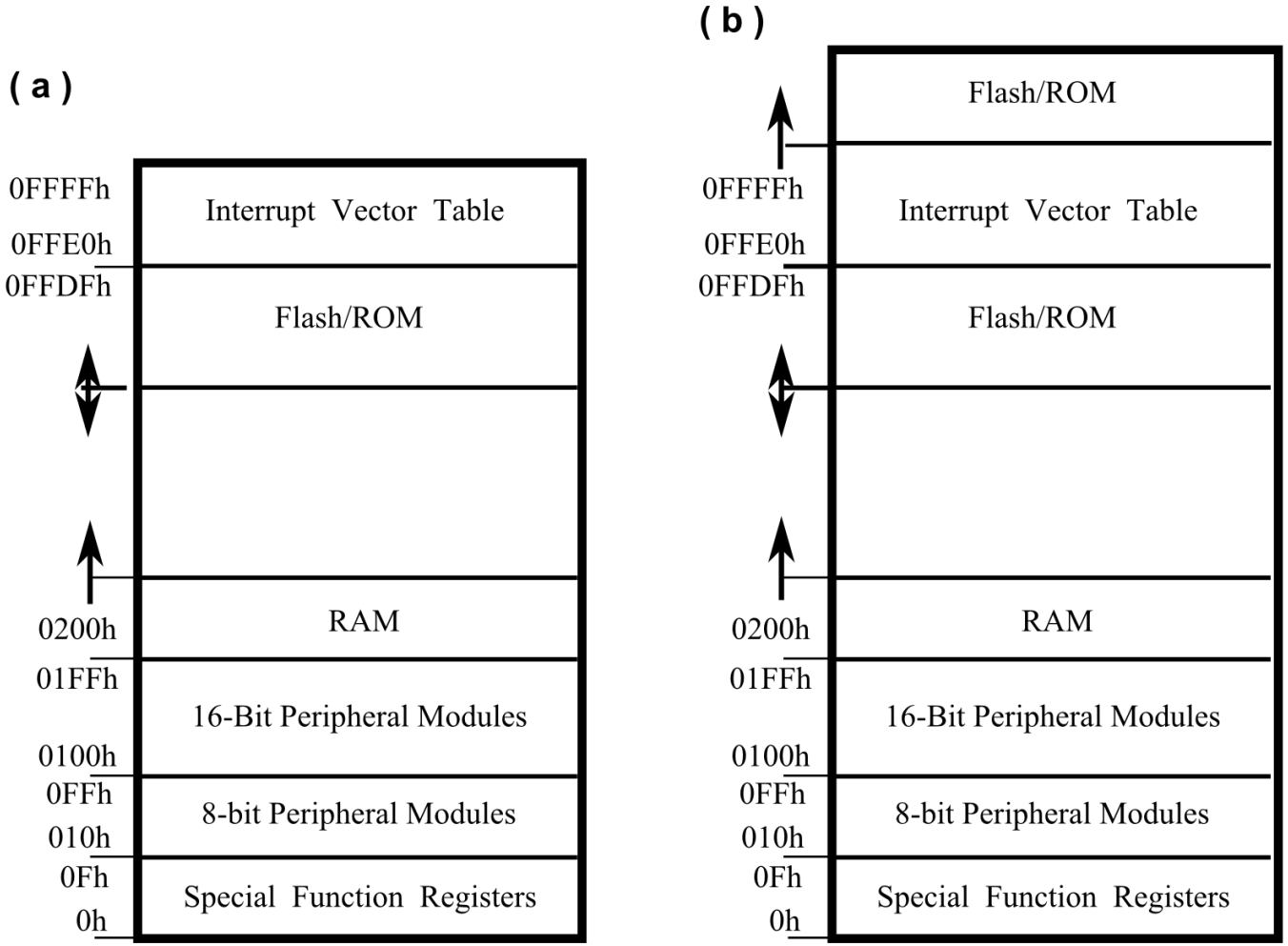


Fig. 3.14 MSP430 global memory maps (*Courtesy of Texas Instruments, Inc*). **a** 16-bit address bus memory map, **b** 20-bit address bus memory map

Address Space

- **Mapped into a single, contiguous address space:**
  - All memory, including RAM, Flash/ROM, information memory, special function registers (SFRs), and peripheral registers.
  - **Memory Map:**

Memory Address		Description	Access
End:	0FFFFh	**Interrupt Vector Table**	Word/Byte
Start:	0FFE0h		
End:	0FFDFh	**Flash/ROM**	Word/Byte
Start *:	0F800h		
	01100h		
End *:	010FFh	**Information Memory (Flash devices only)**	Word/Byte
	0107Fh		
Start:	01000h		
End:	0FFFh	**Boot Memory (Flash devices only)**	Word/Byte
Start:	0C00h		
End *:	09FFh	**RAM**	Word/Byte
	027Fh		
Start:	0200h		
End:	01FFh	**16-bit Peripheral modules**	Word
Start:	0100h		
End:	00FFh	**8-bit Peripheral modules**	Byte
Start:	0010h		
End:	000Fh	**Special Function Registers**	Byte
Start:	0000h		

MSP430

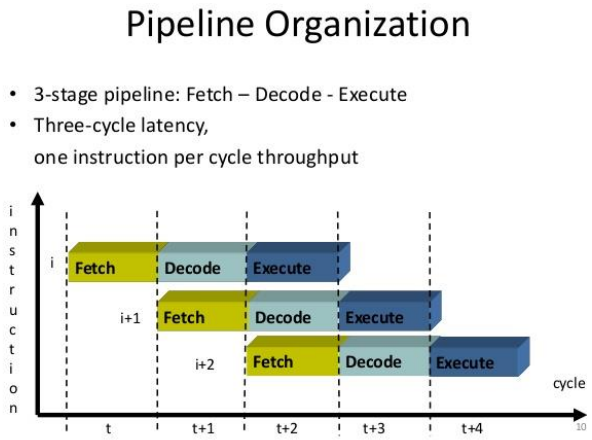
- The CPU is identical for all members of the ’430 family.
- 3-stage instruction pipeline, instruction decoding, a 16-bit ALU, four dedicated-use registers, and twelve working (or scratchpad) registers
- The CPU is connected to its memory through two 16-bit busses, one for addressing, and the other for data
- All memory, including RAM, ROM, information memory, special function registers, and peripheral registers are mapped into a single, contiguous address space.

Central Processing Unit (MSP430 CPU) (1/7)

- **RISC (Reduced Instructions Set Computing) architecture:**
  - Instructions are reduced to the basic ones (short set):
    - 27 physical instructions;
    - 24 emulated instructions.
  - This provides simpler and faster instruction decoding;
  - Interconnect by a using a common memory address bus (MAB) and memory data bus (MDB) - Von Neumann architecture:
    - Makes use of only one storage structure for data and instructions sets.
    - The separation of the storage processing unit is implicit;
    - Instructions are treated as data (programmable).

Central Processing Unit (MSP430 CPU) (2/7)

- **RISC (Reduced Instructions Set Computing) type architecture:**
  - Uses a 3-stage instruction pipeline
    - Fetch, Decode and Execute
  - 16 bit ALU;
  - 4 dedicated-use registers;
  - 12 working registers.



- **Address bus has 16 bit so it can address 64 kB (including RAM + Flash + Registers);**
- **Arithmetic Logic Unit (ALU):**
  - Addition, subtraction, comparison and logical (AND, OR, XOR) operations;
  - Operations can affect the overflow, zero, negative, and carry flags of the SR (Status Register).

Data Bus

- The set of lines carrying data and instructions to or from the CPU is called the *data bus*.
- A *read* operation occurs when information is being transferred *into* the CPU.
- A data bus transfer *out from* the CPU into memory or into a peripheral device, is called a *write* operation.
- Note that the designation of a transfer on the data bus as read or write is always made with respect to the CPU.
- Data bus lines are generally bi-directional because the same set of lines allows us to carry information to or from the CPU.
- One transfer of information is referred to as *data bus transaction*.
- The number of lines in the data bus determines the maximum *data width* the CPU can handle in a single transaction; wider data transfers are possible, but require multiple data bus transactions

MSP430 REGISTERS

- Based on a 16-bit RISC architecture
  - CPUX: Extends base architecture to 20-bit wide
- Register Structure
  - Organized as a 16, 16-bit register file (R0 – R15)
    - 4 registers (R0, R1, R2 and R3) have dedicated functions;
    - 12 register are working registers (R4 to R15) for general use.
- Special Purpose Registers
  - Program Counter (PC): named R0 or PC
  - Stack Pointer (SP): named R1 or SP
  - Status Register (SR): named R2 or SR
    - Has a dual function as (SR) and as Constant Generator 1 (CG1)
  - Constant Generator 2, named CG2 or R3
- PC & SP always point to even addresses
  - Their LSB is always 0

Central Processing Unit (MSP430 CPU) (3/7)

- **R0: Program Counter (PC):**
  - Points to the next instruction to be read from memory and executed by the CPU.

Program Counter

- The Program Counter is located in R0.
- Individual memory location addresses are 8-bit, but all instructions are 16 bit, the PC is constrained to even numbers (i.e. the LSB of the PC is always zero).
- Avoid direct manipulation of the PC except following:
- **Example: Switch Statement via Manual PC Control**

```
mov value,R15          ; Put the Switch value into R15
cmp R15,#8             ; range checking
jge outofrange         ; If R15>7, do not use PC Switch
cmp #0,R15             ; more range checking
jn outofrange
rla R15                ; Multiply R15 by two, since PC is always even
rla R15                ; Double R15 again, since symbolic jmp is 2 words long
add R15,PC             ; PC goes to proper jump
jmp value0
jmp value1
jmp value2
jmp value3
jmp value4
jmp value5
jmp value6
jmp value7
outofrange
jmp RangeError
```

Central Processing Unit (MSP430 CPU) (4/7)

- **R1: Stack Pointer (SP):**
  - 1st: stack can be used by user to store data for later use (instructions: store by PUSH, retrieve by POP);
  - 2nd: stack can be used by user or by compiler for subroutine parameters (PUSH, POP in calling routine; addressed via offset calculation on stack pointer (SP) in called subroutine);
  - 3rd: used by subroutine calls to store the program counter value for return at subroutine's end (RET);
  - 4th: used by interrupt - system stores the actual PC value first, then the actual status register content (on top of stack) on return from interrupt (RETI) the system get the same status as just before the interrupt happened (as long as none has changed the value on TOS) and the same program counter value from stack.

Stack Pointer

- The Stack Pointer is implemented in R1. Like the Program Counter, the LSB is fixed as a zero value, so the value is always even.
- The stack is implemented in RAM, and it is common practice to start the SP at the top (TOS-highest valid value) of RAM.
- Things to watch out for:
  - Asymmetric push/pop combinations.
  - Stack encroachment problem

Central Processing Unit (MSP430 CPU) (5/7)

❑ R2: Status Register (SR):

- Stores status and control bits;
- System flags are changed automatically by the CPU;
- Reserved bits are used to support the constant generator.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Reserved for CG1							V	SCG1	SCG0	OSCOFF	CPUOFF	GIE	N	Z	C

Bit		Description
8	V	Overflow bit. V = 1 ⇒ Result of an arithmetic operation overflows the signed-variable range.
7	SCG1	System clock generator 1. SCG1 = 1 ⇒ DCO generator is turned off – if not used for MCLK or SMCLK
6	SCG0	System clock generator 0. SCG0 = 1 ⇒ FLL+ loop control is turned off
5	OSCOFF	Oscillator Off. OSCOFF = 1 ⇒ turns off LFXT1 when it is not used for MCLK or SMCLK
4	CPUOFF	CPU off. CPUOFF = 1 ⇒ disable CPU core.
3	GIE	General interrupt enable. GIE = 1 ⇒ enables maskable interrupts.
2	N	Negative flag. N = 1 ⇒ result of a byte or word operation is negative.
1	Z	Zero flag. Z = 1 ⇒ result of a byte or word operation is 0.
0	C	Carry flag. C = 1 ⇒ result of a byte or word operation produced a carry.

- CPUOFF, OSCOFF, SCG0, and SCG1, which control the mode of operation of the MCU. Setting various combinations of these bits puts the MCU into one of its low-power modes, which is described in the section “Low-Power Modes of Operation”

- All bits are clear in the full-power, active mode. This is the main effect of setting each bit in the MSP430F2xx:
- **CPUOFF** disables MCLK, which stops the CPU and any peripherals that use MCLK.
- **SCG1** disables SMCLK and peripherals that use it.
- **SCG0** disables the DC generator for the DCO (disables the FLL in the MSP430x4xx family).
- **OSCOFF** disables LFXT1.

Central Processing Unit (MSP430 CPU) (6/7)

- **R2/R3: Constant Generator Registers (CG1/CG2):**
  - Depending of the source-register addressing modes (As) value, six constants can be generated without code word or code memory access to retrieve them.
  - This is a very powerful feature which allows the implementation of emulated instructions, for example, instead of implement a core instruction for an increment the constant generator is used.

Register	As	Constant	Remarks
R2	00	-	Register mode
R2	01	(0)	Absolute mode
R2	10	00004h	+4, bit processing
R2	11	00008h	+8, bit processing
R3	00	00000h	0, word processing
R3	01	00001h	+1
R3	10	00002h	+2, bit processing
R3	11	0FFFFh	-1, word processing

Constant Generators

- R2 and R3 function as constant generators, so that register mode may be used instead of immediate mode for some common constants.
- R2 is a dual use register. It serves as the Status Register, as well.
- The use of a constant generator saves a word in the machine instruction.
- For example, mov #1,R7 translates into **4317** (0010 **0011** 00**01** 0111), and
- mov.b #4,R7 into **4267** (0010 **0001** 01**10** 0111).

W(S)	Value in R2	Value in R3
00	——	0000h
01	(0) (absolute mode)	0001h
10	0004h	0002h
11	0008h	0FFFFh

Status Register

- The Status Register is implemented in R2, and is comprised of various system flags.
- The bits of the SR are:
- The Carry Flag (C)
  - Location: SR(0) (the LSB)
  - Function: Identifies when an operation results in a carry. Can be set or cleared by software, or automatically.
  - 1=Carry occurred
  - 0=No carry occurred

- The Zero Flag (Z)
- Location: SR(1)
- Function: Identifies when an operation results in a zero. Can be set or cleared by software, or automatically.
- 1=Zero result occurred
- 0=Nonzero result occurred

- The Negative Flag (N)
- Location: SR(2)
- Function: Identifies when an operation results in a negative. Can be set or cleared by software, or automatically. This flag reflects the value of the MSB of the operation result (Bit 7 for byte operations, and bit 15 for word operations).
- 1=Negative result occurred
- 0=Positive result occurred

- The Global Interrupt Enable (GIE)
  Location: SR(3)
  Function: Enables or disables all maskable interrupts. Can be set or cleared by software, or automatically.
- Interrupts automatically reset this bit, and the reti instruction automatically sets it.
- 1=Interrupts Enabled
- 0=Interrupts Disabled

- The CPU off bit (CPUOff)
  Location: SR(4)
  Function: Enables or disables the CPU core. Can be cleared by software, and is reset by enabled interrupts.
- None of the memory, peripherals, or clocks are affected by this bit. This bit is used as a power saving feature.
- 1=CPU is on
- 0=CPU is off

- The Oscillator off bit (OSCOff)
  Location: SR(5)
  Function: Enables or disables the crystal oscillator circuit (LFXT1).
- Can be cleared by software, and is reset by enabled external interrupts.
- OSCOff shuts down everything, including peripherals. RAM and register contents are preserved. This bit is used as a power saving feature.
- 1=LFXT1 is on
- 0=LFXT1 is off

- The System Clock Generator (SCG1,SCG0)
  Location: SR(7),SR(6)
  Function: These bits, along with OSCOff and CPUOff define the power mode of the device.
- More on this later

- The Overflow Flag (V)
  Location: SR(8)
  Function: Identifies when an operation results in an overflow.
- Can be set or cleared by software, or automatically.
- Overflow occurs when two positive numbers are added together, and the result is negative, or when two negative numbers are added together, and the result is positive.
- 1=Overflow result occurred
- 0=No overflow result occurred

- Four of these flags (Overflow, Negative, Carry, and Zero) drive program control, via instructions such as cmp (compare) and jz (jump if Zero flag is set).

MSP430 REGISTERS

- Status Flags
- Carry (C), Zero (Z), Sign or Negative (N), overflow (V), and global interrupt enable (GIE)
- Other flags
  - CPUOFF, OSCOFF, SCG1 and SCG0
  - Are used to configure the CPU, oscillator and low power modes
- MSP430 ALU
  - 16-bit wide (20-bit in CPUX)
  - Arithmetic ADD, SUB, CMP operations
  - BCD arithmetic
  - Bitwise logic operations
  - Does not provide for multiplication, division, or FP
- Some MSP430 feature a hardware multiplier peripheral device

General Purpose Registers

- Twelve 16-bit working registers, R4 through R15
- Use these registers as much as possible. Any variable which is accessed often should reside in one of these locations, for the sake of efficiency.
- Generally, you may select any of these registers for any purpose, either data or address.
- These general-purpose registers are adequate to store data registers, address pointers, or index values and can be accessed with byte or word instructions.
- However, some development tools will reserve R4 and R5 for debug information. Different compilers will use these registers in different fashions, as well.
- Know your development tools.

Special Function Registers

- Special function registers are, memory-mapped registers with special dedicated functions
- There are, sixteen of these registers, at memory locations 0000h through 000Fh.
- Only the first six are used.
- Locations 0000h and 0001h contain interrupt enables
- Locations 0002h and 0003h contain interrupt flags
- Locations 0004h and 0005h contain module enable flags Only two bits are implemented in each byte. These bits are used for the USARTs.

0010h-001Fh	I/O ports 3 and 4 control (Byte addressable, All devices), I/O port 0 (Byte addressable, '3xx devices)
0006h-000Fh	Unused (All devices)
0005h	Module Enables 2 (Byte Addressable, all devices)
0004h	Module Enables 1 (Byte Addressable, all devices)
0003h	Interrupt Flags 2 (Byte Addressable, all devices)
0002h	Interrupt Flags 1 (Byte Addressable, all devices)
0001h	Interrupt Enables 2 (Byte Addressable, all devices)
0000h	Interrupt Enables 1 (Byte Addressable, all devices)

>> Contents

Peripheral Registers

- All on-chip peripheral registers are mapped into memory, immediately after the special function registers.
- Byte-addressable, which are mapped in the space from 010h to 0FFh, and
- Word-addressable, which are mapped from 0100h to 01FFh.

01B0h-01FFh	Unused (All devices)
01A0h-01Afh	ADC Control ('1xx and '4xx devices) / Unused ('3xx devices)
0180h-019Fh	Timer B ('1xx devices) / Unused ('3xx and '4xx devices)
0160h-017Fh	Timer A (All devices)
0140h-015Fh	ADC Conversion ('1xx and '4xx devices) / Unused ('3xx devices)
0130h-013Fh	Multiplier (All devices)
0120h-012Fh	Watchdog timer, applicable flash control (All devices)
0110h-011Fh	ADC ('3xx devices) / Unused ('1xx and '4xx devices)
0100h-010Fh	Unused (All devices)
00B0h-00FFh	Unused (All devices)
0090h-00Afh	LCD (Byte addressed, '4xx devices) / Unused ('1xx and '3xx devices)
0080h-008Fh	ADC memory control (Byte addressed, '1xx and '4xx devices) / Unused ('3xx devices)
0070h-007Fh	USART (Byte addressed, All devices)
0060h-006Fh	Unused (All devices)
0050h-005Fh	System Clock (Byte addressable, All devices) / Comparator ('1xx and '4xx devices) / Brownout ('4xx devices) / EPROM and crystal buffer ('3xx devices)
0040h-004Fh	Basic Timer and 8-bit Counter (Byte addressable, '3xx and '4xx devices) / Unused ('1xx devices).
0030h-003Fh	I/O ports 5 and 6 control (Byte addressable, '1xx and '4xx devices) / LCD (Byte addressable, '3xx devices)
0020h-002Fh	I/O ports 1 and 2 control (Byte addressable, All devices)

RAM

- RAM always begins at location 0200h, and is contiguous up to its final address.
- RAM is used for all scratchpad variables, global variables, and the stack
- The developer needs to be careful that scratchpad allocation and stack usage do not encroach on each other, or on global variables
- Accidental sharing of RAM is a very common bug, and can be difficult to chase down
- Be consistent about use. Locate the stack at the very end of the RAM space, and place your most commonly used globals at the beginning.

Memory Address	Description
0FFE0h-0FFFFh	Interrupt Vectors
0FFDFh	End of code space-All devices
0F800h	Start of code space-2K devices
0F000h	Start of code space-4k devices
0E000h	Start of code space-8k devices
0D000h	Start of code space-12k devices
0C000h	Start of code space-16k devices
0A000h	Start of code space-24k devices
08000h	Start of code space-32k devices
04000h	Start of code space-48k devices
01100h	Start of code space-60k devices
010FFh	End of Information Memory: Flash devices except 'F110 and 'F1101
0107Fh	End of Information Memory: 'F110 and 'F1101
01000h	Start of Information Memory: Flash devices only
0FFFh	End of Boot Memory: Flash devices only
0C00h	Start of Boot Memory: Flash devices only
09FFh	End of RAM-2k devices
05FFh	End of RAM-1k devices
03FFh	End of RAM-512 byte devices
02FFh	End of RAM-256 byte devices
027Fh	End of RAM-128 byte devices
0200h	Start of RAM-All devices

Boot Memory (flash devices only)

- Boot memory is implemented in flash devices only, located in memory locations 0C00h through 0FFFh.
- It is the only hard-coded ROM space in the flash devices.
- This memory contains the bootstrap loader, which is used for programming of flash blocks, via a USART modüle.
- Contains a program to communicate using a standard serial protocol, often with the COM port of a PC. This can be used to program the chip but improvements in other methods of communication have made it less important than in the past, particularly for development. All MSP430s had a bootstrap loader until the F20xx, from which it was omitted to improve security.

Information Memory (flash devices only)

- Flash devices in the ’430 family have the added feature of information memory.
- This information memory acts as onboard EEPROM, allowing critical variables to be preserved through power down.
- A 256B block of flash memory for storage of nonvolatile data. Such as an address for a network, or variables that should be retained even when power is removed. For example, a printer might remember the settings from when it was last used and keep a count of the total number of pages printed.
  - It is divided into two 128-byte segments.
  - The first of these segments is located at addresses 01000h through 0107Fh, and the second is at 01080h through 010FFh.

Code Memory

- Holds the program, including the executable code itself and any constant data. The F2013 has 2KB but the F2003 only 1KB.
- Code memory is always contiguous at the end of the address space (i.e. always runs to location 0FFFFh).
- The code runs from 01100h to 0FFE0h for 60K devices
- The code runs from 0E000 to 0FFE0h for 8K devices.
- All code, tables, and hard-coded constants reside in this memory space.

Interrupt Vectors

- Interrupt vectors are located at the very end of memory space, in locations 0FFE0h through 0FFFEh.
- Used to handle "exceptions," when normal operation of the processor is interrupted or when the device is reset. This table was smaller and started at 0xFFE0 in earlier devices.
- Priority of the interrupt vector increases with the word address.

Vector Address	Priority	'2xx	'4xx
0xFFFE	31, Highest	**Hard Reset/ Watchdog**	**Hard Reset/ Watchdog**
0xFFFC	30	**Oscillator/ Flash/NMI**	**Oscillator/ Flash/NMI**
0xFFFA	29	**Timer_B** (22x2, 22x4, 23x, 24x, 26x)	Timer_B ('43x and'44x)
0xFFF8	28	**Timer_B** (22x2, 22x4, 23x, 24x)	Timer_B ('43x and'44x)
0xFFF6	27	**Comparator_A+** (20x1, 21x1, 23x, 24x, 26x)	**Comparator**
0xFFF4	26	**Watchdog Timer+**	**Watchdog Timer**
0xFFF2	25	**Timer_A**	**USART0 Rx** ('43x and'44x)
0xFFF0	24	**Timer_A**	**USART0 Tx** ('43x and'44x)
0xFFEE	23	**USCI Rx** (22x2, 22x4, 23x, 24x, 26x) **I2C status** (23x, 24x)	**ADC** ('43x and'44x)
0xFFEC	22	**USCI Tx** (22x2, 22x4, 23x, 24x, 26x) **I2C Rx/Tx** (23x, 24x, 26x)	**Timer_A**
0xFFEA	21	**ADC10** (20x2 22x2, 22x4) **ADC12** (23x, 24x, 26x) **SD16_A** (20x3)	**Timer_A**
0xFFE8	20	**USI** (20x2, 20x3)	**Port 1**
0xFFE6	19	**Port P2**	**USART1 Rx** ('44x)
0xFFE4	18	**Port P1**	**USART1 Tx** ('44x)
0xFFE2	17	**USCI Rx** (23x, 24x, 26x) **I2C status** (241x, 261x)	**Port 2**
0xFFE0	16	**USCI Tx** (23x,24x) **I2C Rx/Tx** (241x, 261x)	**Basic Timer**
	15	**DMA** (241x, 261x)	
	14	**DAC12** (241x, 261)	
	13 to 0, Lowest	**Reserved**	

>> Contents

Memory Map Summary

01B0h-01FFh	Unused (All devices)
01A0h-01Afh	ADC Control
0180h-019Fh	Timer B
0160h-017Fh	Timer A
0140h-015Fh	ADC Conversion
0130h-013Fh	Multiplier
0120h-012Fh	Watchdog timer
0110h-011Fh	ADC
0100h-010Fh	Unused (All devices)
00B0h-00FFh	Unused (All devices)
0090h-00Afh	LCD
0080h-008Fh	ADC memory control

Memory Map Summary

0070h-007Fh	USART
0060h-006Fh	Unused
0050h-005Fh	System Clock (Byte addressable, All devices) / Comparator
0040h-004Fh	Basic Timer and 8-bit Counter
0030h-003Fh	I/O ports 5 and 6 control
0020h-002Fh	I/O ports 1 and 2 control
0010h-001Fh	I/O ports 3 and 4 control
0006h-000Fh	Unused
0005h	Module Enables 2
0004h	Module Enables 1
0003h	Interrupt Flags 2
0002h	Interrupt Flags 1
0001h	Interrupt Enables 2
0000h	Interrupt Enables 1

IO SUBSYSTEM

- All the components other than the CPU & memory connected to the system buses
  - Timers & Watchdog timers
  - Communication interfaces
  - Analog to Digital Converter (ADC)
  - Digital to Analog Converter (DAC)
  - Development peripherals
- Its organization resembles that of memory
- Memory mapped I/O
  - Address space inside the memory space, uses same instructions used to access memory
- I/O mapped I/O
  - Separate address space, instructions, and signals for I/O (rarely used in modern processors)

CONCEPTUAL IO INTERFACE

- Serves as a bridge between a device & the buses
- Has one or more registers each with their own addresses
  - Data, control, and status registers
- Accessed like memory (read/write)

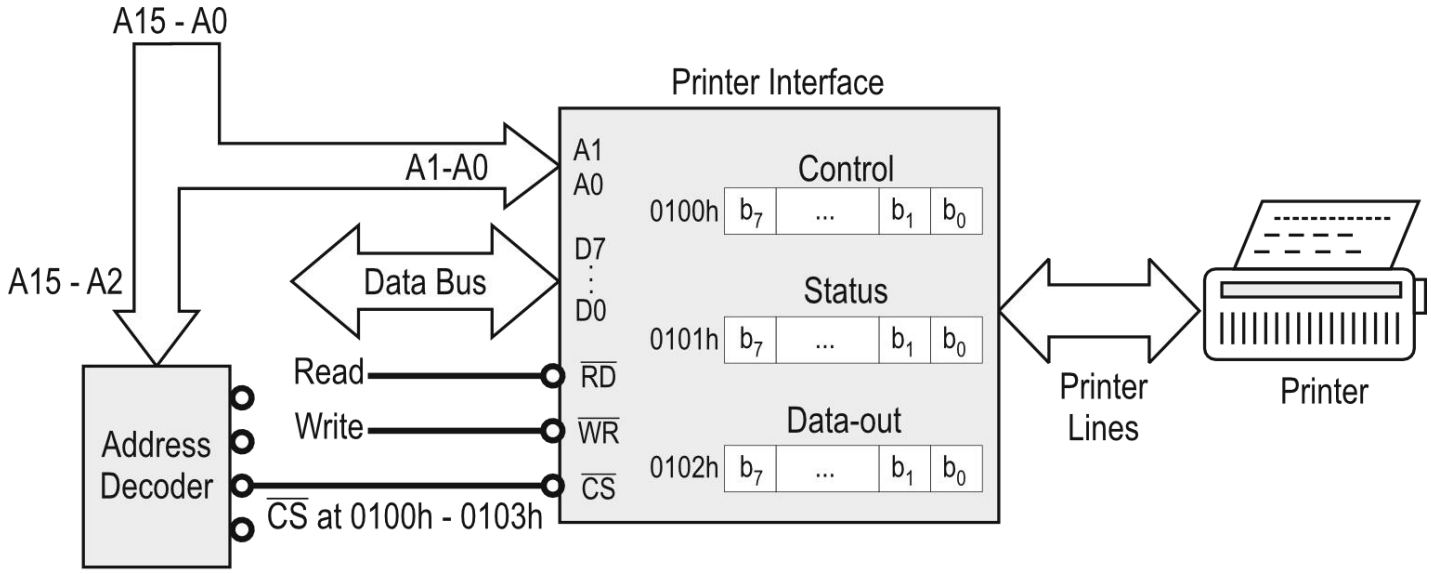


Fig. 3.17 Connection of printer interface to CPU buses and printer itself

CONCEPTUAL IO INTERFACE

- Includes lines to connect to the system buses, I/O device connection lines, and a set of internal registers
- Internal register types
- Control: to configure the operation of the device & interface
- Status: to allow inquiries about the device & interface status
- Data: for exchanging data with the device

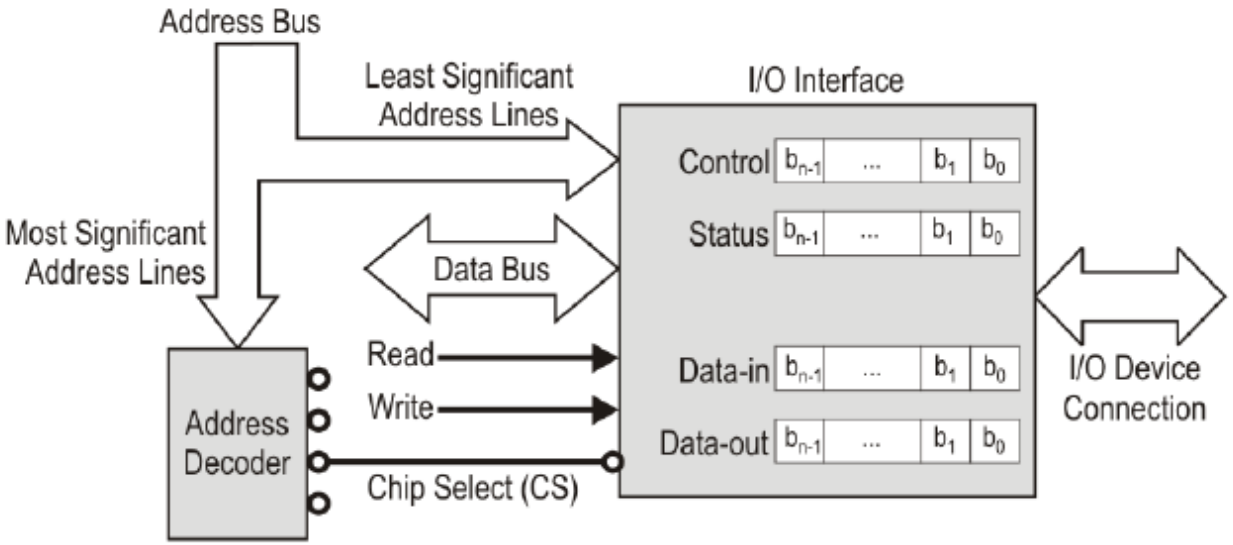


Fig. 3.16 Anatomy of an input/output (I/O) interface

INTERFACE EXAMPLE

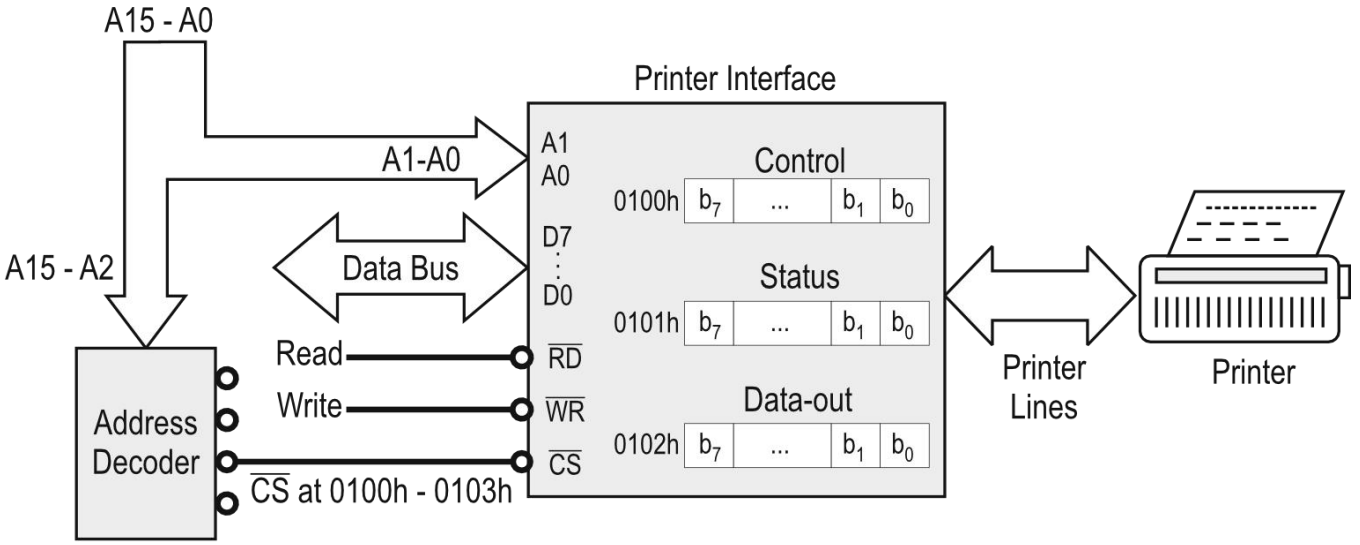


Fig. 3.17 Connection of printer interface to CPU buses and printer itself

Table 3.3 Internal addresses for sample printer interface

A1	A0	Register
0	0	Control
0	1	Status
1	0	Data-out
1	1	Not used

INTERFACE EXAMPLE

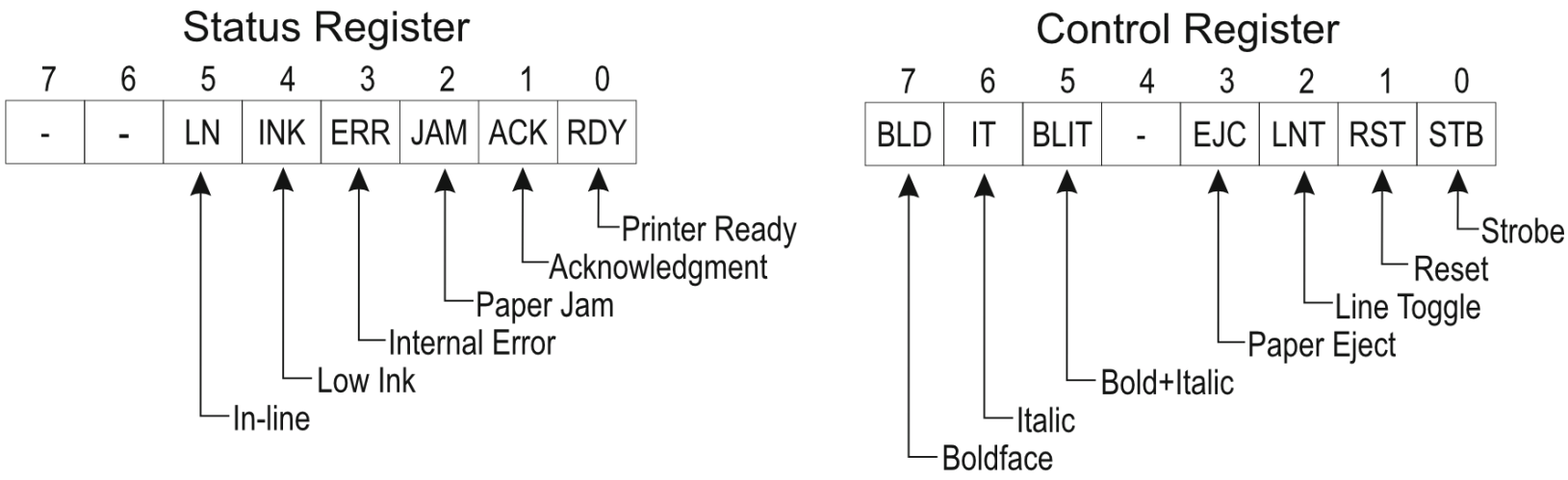


Fig. 3.18 Status and control registers in printer interface example

IO pin HARDWARE CONFIGURATION

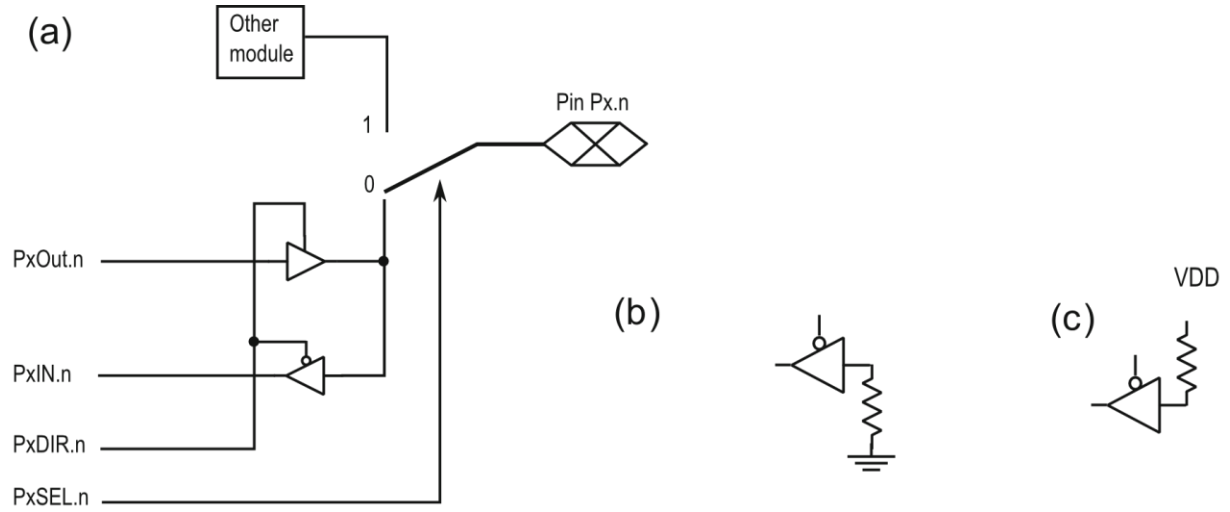


Fig. 3.19 Basic IO Pin hardware configuration: **a** Basic I/O register's functions; **b** pull-down resistor for inputs; **c** pull-up resistors

Direction Register (PxDIR): *Selects in or out direction function for pin, with 1 for output direction and 0 for input direction.*

Input Register (PxIN): *This is a read-only register. The value changes automatically when the input itself changes.*

Output Register (PxOUT): *to write signal to output. This is a read-and-write register.*

Function Select Register (PxSEL): *Used to select between I/O port or peripheral module function. With PxSEL.n = 0, pin Px.n operates as an I/O pin port; with PxSEL.n = 1, as a module pin.*

Timing Diagrams

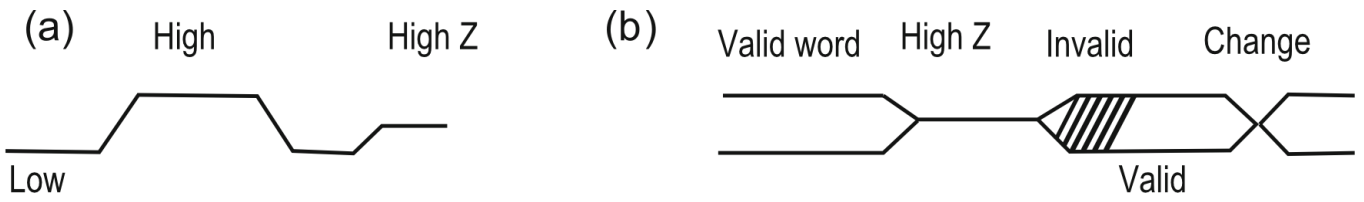


Fig. 3.20 Definitions of timing concepts. **a** Single signal timing convention, **b** Bus timing convention

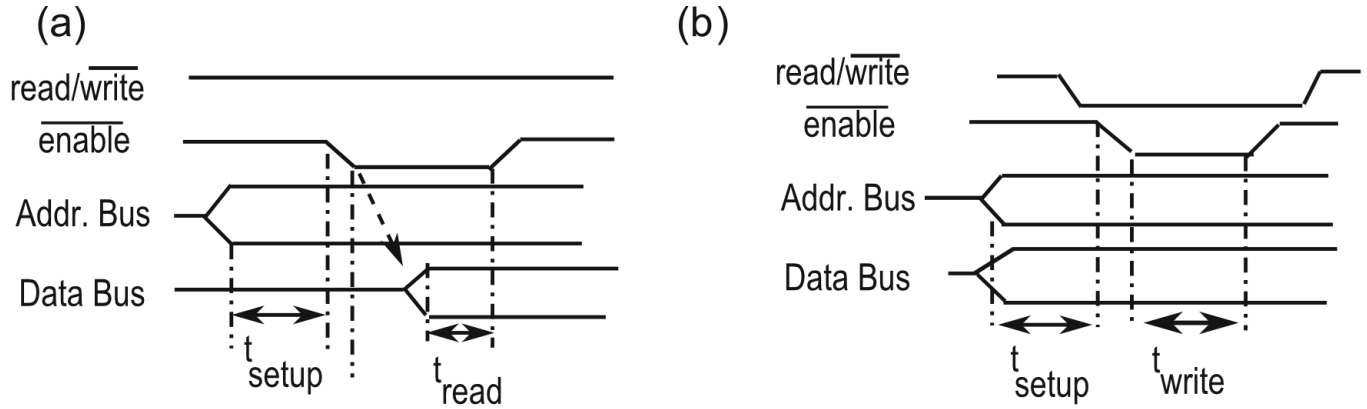


Fig. 3.21 Example of simplified write and read timings. **a** Read timing diagram, **b** Write timing diagram

>> Contents

MSP430 IO Subsystem

- Memory mapped from address 0x0000h to 0x01FFh
- Information stored in special function registers (SFR)
  - Located from 0x0000 to 0x000F
  - Control the operation of MSP430 peripherals
- Available Peripherals (Specific list is device dependent)
  - General Purpose I/O Pins
    - Arranged as multiple 8-bit I/O ports
  - 16-bit Timers
    - General purpose and Watchdog
  - Communication Support
    - USART, SPI, I2C
  - Data Converters
    - ADCs and DACs
  - System Support
  - POR and brownout reset circuitry
  - Clock generators and supply voltage supervisors

MSP430 Package Pinout

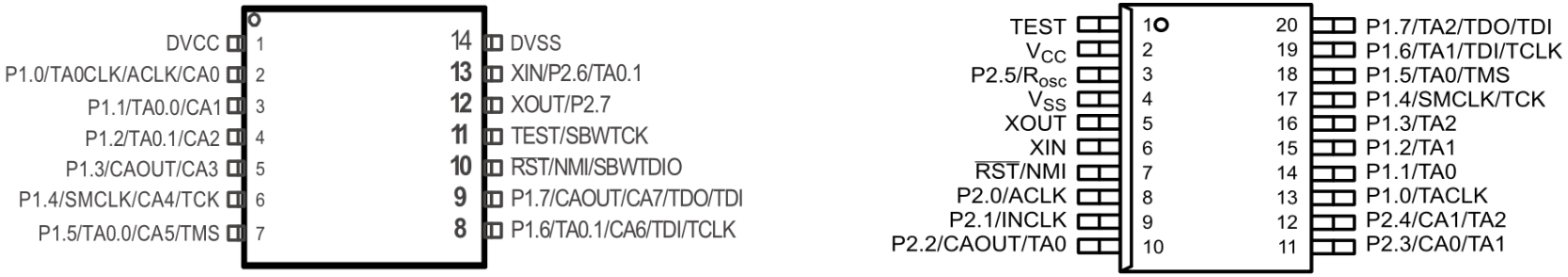


Fig. 3.22 Package pinout of two MSP430 microcontroller models: **a** MSPG2231 Pin description, **b** MSP430x1xx Pin description (*Courtesy of Texas Instruments, Inc.)*

MSP430x1xx series

The MSP430x1xx Series is the basic generation without an embedded LCD controller. They are generally smaller than the '3xx generation. These flash- or ROM-based ultra-low-power MCUs offer 8 MIPS, 1.8–3.6 V operation, up to 60 KB flash, and a wide range of analog and digital peripherals.

- Power specification overview, as low as:
  - 0.1 µA RAM retention
  - 0.7 µA real-time clock mode
  - 200 µA / MIPS active
  - Features fast wake-up from standby mode in less than 6 µs.
- Device parameters
  - Flash options: 1–60 KB
  - ROM options: 1–16 KB
  - RAM : 128 B–10 KB
  - GPIO options: 14, 22, 48 pins
  - ADC options: Slope, 10 & 12-bit SAR
  - Other integrated peripherals: 12-bit DAC, up to 2 16-bit timers, watchdog timer, brown-out reset, SVS, USART module (UART, SPI), DMA, 16×16 multiplier, Comparator_A, temperature sensor

MSP430F2xx series

The MSP430F2xx Series are similar to the '1xx generation, but operate at even lower power, support up to 16 MHz operation, and have a more accurate (±2%) on-chip clock that makes it easier to operate without an external crystal. These flash-based ultra-low power devices offer 1.8–3.6 V operation. Includes the very-low power oscillator (VLO), internal pull-up/pull-down resistors, and low-pin count options.

Power specification overview, as low as:
0.1 µA RAM retention
0.3 µA standby mode (VLO)
0.7 µA real-time clock mode
220 µA / MIPS active
Feature ultra-fast wake-up from standby mode in less than 1 µs
Device parameters
Flash options: 1–120 KB
RAM options: 128 B – 8 KB
GPIO options: 10, 11, 16, 24, 32, and 48 pins
ADC options: Slope, 10 & 12-bit SAR, 16 & 24-bit Sigma Delta
Other integrated peripherals: operational amplifiers, 12-bit DAC, up to 2 16-bit timers, watchdog timer, brown-out reset, SVS, USI module (I^2C, SPI), USCI module, DMA, 16×16 multiplier, Comparator_A+, temperature sensor

MSP430G2xx series
The MSP430G2xx Value Series features flash-based Ultra-Low Power MCUs up to 16 MIPS with 1.8–3.6 V operation. Includes the Very-Low power Oscillator (VLO), internal pull-up/pull-down resistors, and low-pin count options, at lower prices than the MSP430F2xx series.

Ultra-Low Power, as low as (@2.2 V):
0.1 µA RAM retention
0.4 µA Standby mode (VLO)
0.7 µA real-time clock mode
220 µA / MIPS active
Ultra-Fast Wake-Up From Standby Mode in <1 µs
Device parameters
Flash options: 0.5–56 KB
RAM options: 128 B–4 KB
GPIO options: 10, 16, 24, 32 pins
ADC options: Slope, 10-bit SAR
Other integrated peripherals: Capacitive Touch I/O, up to 3 16-bit timers, watchdog timer, brown-out reset, USI module (I^2C, SPI), USCI module, Comparator_A+, Temp sensor

MSP430x3xx series

The MSP430x3xx Series is the oldest generation, designed for portable instrumentation with an embedded LCD controller. This also includes a frequency-locked loop oscillator that can automatically synchronize to a low-speed (32 kHz) crystal. This generation does not support EEPROM memory, only mask ROM and UV-eraseable and one-time programmable EPROM. Later generations provide only flash memory and mask ROM options. These devices offer 2.5–5.5 V operation, up to 32 KB ROM.

Power specification overview, as low as:
0.1 µA RAM retention
0.9 µA real-time clock mode
160 µA / MIPS active
Features fast wake-up from standby mode in less than 6 µs.
Device parameters:
ROM options: 2–32 KB
RAM options: 512 B–1 KB
GPIO options: 14, 40 pins
ADC options: Slope, 14-bit SAR
Other integrated peripherals: LCD controller, multiplier

MSP430x4xx series

The MSP430x4xx Series are similar to the '3xx generation, but include an integrated LCD controller, and are larger and more capable. These flash or ROM based devices offers 8–16 MIPS at 1.8–3.6 V operation, with FLL, and SVS. Ideal for low power metering and medical applications.

Power specification overview, as low as:
0.1 µA RAM retention
0.7 µA real-time clock mode
200 µA / MIPS active
Features fast wake-up from standby mode in less than 6 µs.
Device parameters:
Flash/ROM options: 4 – 120 KB
RAM options: 256 B – 8 KB
GPIO options: 14, 32, 48, 56, 68, 72, 80 pins
ADC options: Slope, 10 & 12-bit SAR, 16-bit Sigma Delta
Other integrated peripherals: SCAN_IF, ESP430, 12-bit DAC, Op Amps, RTC, up to 2 16-bit timers, watchdog timer, basic timer, brown-out reset, SVS, USART module (UART, SPI), USCI module, LCD Controller, DMA, 16×16 & 32x32 multiplier, Comparator_A, temperature sensor, 8 MIPS CPU Speed

MSP430x5xx series

The MSP430x5xx Series are able to run up to 25 MHz, have up to 512 KB flash memory and up to 66 KB RAM. This flash-based family features low active power consumption with up to 25 MIPS at 1.8–3.6 V operation (165 uA/MIPS). Includes an innovative power management module for optimal power consumption and integrated USB.[3]

Power specification overview, as low as:
0.1 µA RAM retention
2.5 µA real-time clock mode
165 µA / MIPS active
Features fast wake-up from standby mode in less than 5 µs.
Device parameters:
Flash options: up to 512 KB
RAM options: up to 66 KB
ADC options: 10 & 12-bit SAR
GPIO options: 29, 31, 47, 48, 63, 67, 74, 87 pins
Other integrated peripherals: High resolution PWM, 5 V I/O's, USB, backup battery switch, up to 4 16-bit timers, watchdog timer, Real-Time Clock, brown-out reset, SVS, USCI module, DMA, 32x32 multiplier, Comp B, temperature sensor

MSP430x6xx series
The MSP430x6xx Series are able to run up to 25 MHz, have up to 512 KB flash memory and up to 66 KB RAM. This flash-based family features low active power consumption with up to 25 MIPS at 1.8–3.6 V operation (165 uA/MIPS). Includes an innovative power management module for optimal power consumption and integrated USB.

Power specification overview, as low as:
0.1 µA RAM retention
2.5 µA real-time clock mode
165 µA / MIPS active
Features fast wake-up from standby mode in less than 5 µs.
Device parameters:
Flash options: up to 512 KB
RAM options: up to 66 KB
ADC options: 12-bit SAR
GPIO options: 74 pins
Other integrated peripherals: USB, LCD, DAC, Comparator_B, DMA, 32x32 multiplier, power management module (BOR, SVS, SVM, LDO), watchdog timer, RTC, Temp sensor

How to Read Datasheets (1/6)

- **Manufacturers of electronic components provide datasheets containing the specifications detailing the part/device characteristics;**

- **Datasheets give the electrical characteristics of the device and the pin-out functions, but without detailing the internal operation;**

- **More complex devices are provided with documents that aid the development of applications, such as:**
  - Application notes;
  - User's guides;
  - Designer's guides;
  - Package drawings, etc…

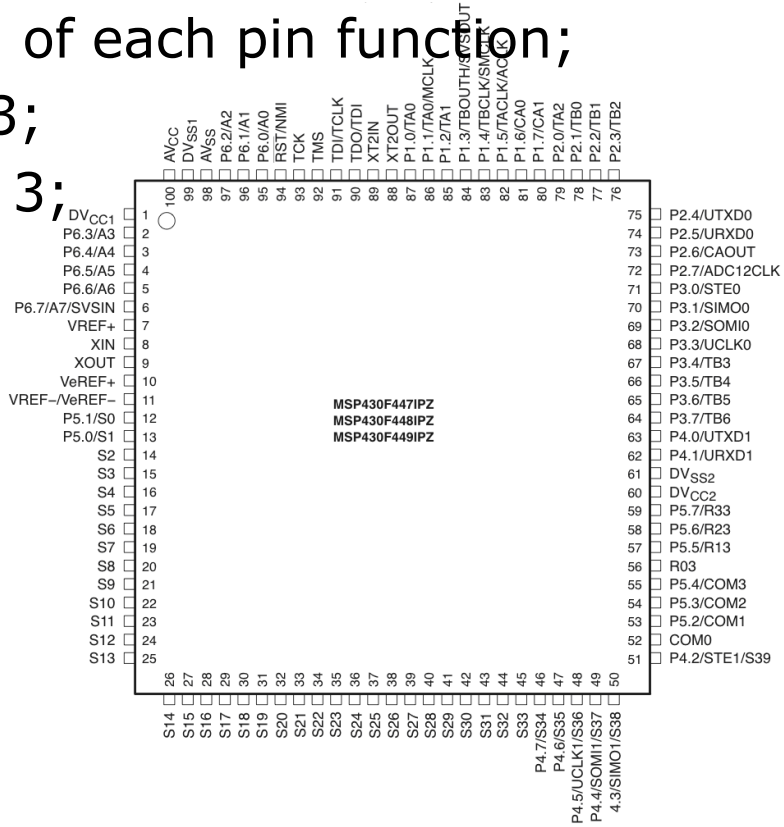
>> Contents

How to Read Datasheets (2/6)

- **Datasheets include information:**
  - Concerning the part number of the device or device series;
  - Electrical characteristics:
    - Maximum and minimum operating voltages;
    - Operating temperature range e.g. 0 to 70 degrees C;
    - Output drive capacity for each output pin, as well as an overall limit for the entire chip;
    - Clock frequencies;
    - Pin out electrical characteristics (capacitance, inductance, resistance);
    - Noise tolerance or the noise generated by the device itself;
    - Physical tolerances…

How to Read Datasheets (3/6)

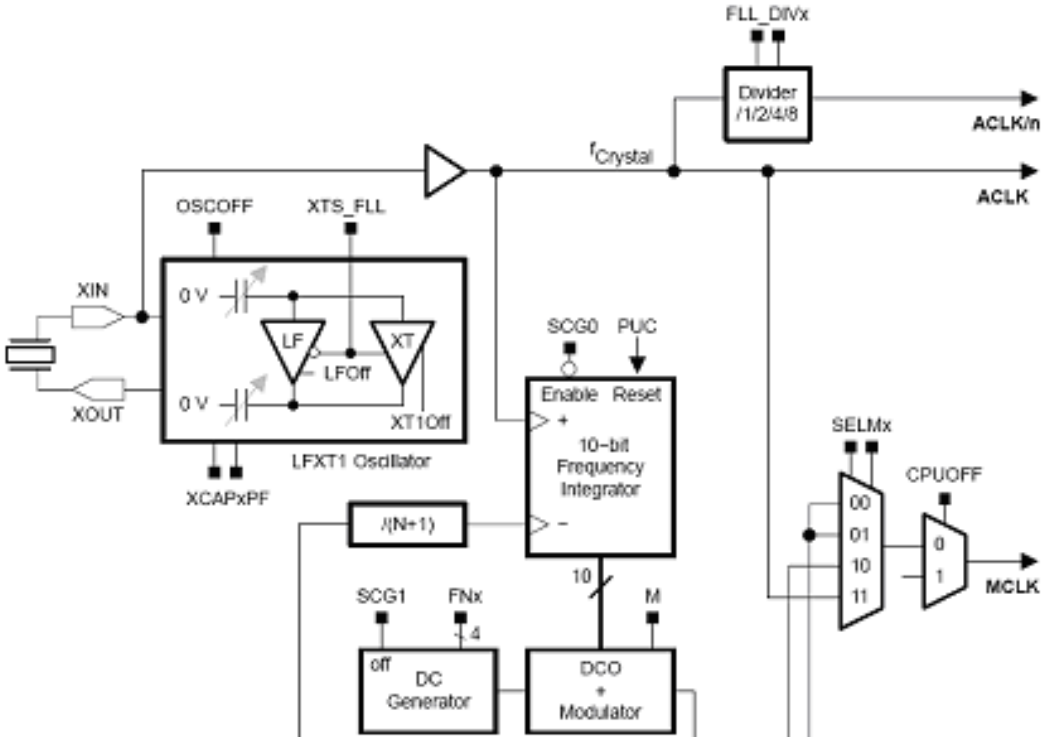
- **MSP430 device datasheet:**
  - Device has a large number of peripherals;
  - Each input/output pin usually has more than one function;
  - It has a table with the description of each pin function;
  - Example, Pin number 2 = P6.3/A3;
    - Digital Input/Output Port 6 bit 3;
    - 3rd analogue input.



>> Contents

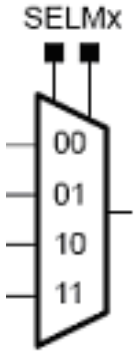
How to Read Datasheets (4/6)

- **MSP430 User's Guide:**
  - Most peripherals are represented by Block Diagrams.
  - Example: Part of the MSP430F44x clock module block diagram:



How to Read Datasheets (5/6)

- **MSP430 User's Guide:**
  - Example: Part of the MSP430F44x clock module block diagram: Detail SELMx;



  - Multiplexed block: (4 inputs and 1 output):
    - SELMx = 00: Output routed from the first input to the multiplexer output;
    - SELMx = 01: Output routed from the second one and so on;
    - SELMx is a 2-bit *mnemonic*: SELM1 (MSB), SELM0 (LSB).
  - To use the peripheral, it is necessary to find out how the register(s) need to be configured:
    - SELMx is in the FLL_CTL1 register.

How to Read Datasheets (6/6)

- **MSP430 User's Guide:**
  - SELMx are the 3rd and 4th bits of FLL_CTL1 control register.

FLL_CTL1, FLL+ control register 1

7	6	5	4	3	2	1	0
-	SMCLKOFF	XT2OFF	SELMx		SELS	FLL_DIVx	

Bit		Description
6	SMCLKOFF	Disable the submain clock signal (SMCLK): SMCLKOFF = 0 ⇒ SMCLK active SMCLKOFF = 1 ⇒ SMCLK inactive
5	XT2OFF	Disable the second crystal oscillator (XT2): XT2OFF = 0 ⇒ XT2 active XT2OFF = 1 ⇒ XT2 inactive
4-3	SELMx	Select the master clock (MCLK) source: SELM1 SELM0 = 0 0 ⇒ DCO SELM1 SELM0 = 0 1 ⇒ DCO SELM1 SELM0 = 1 0 ⇒ XT2 SELM1 SELM0 = 1 1 ⇒ LFXT1
2	SELS	Select the submain clock (SMCLK) source: SELS = 0 ⇒ DCO SELS = 1 ⇒ XT2
1-0	FLL_DIVx	Select the auxiliary clock (ACLK) signal divider: FLL_DIV_0 = 0 0 ⇒ Divider factor: /1 FLL_DIV_1 = 0 1 ⇒ Divider factor: /2 FLL_DIV_2 = 1 0 ⇒ Divider factor: /4 FLL_DIV_3 = 1 1 ⇒ Divider factor: /8